# Doping-Induced Enhancement of Grain Boundary Critical Currents

G. Hammerl, H. Bielefeldt, B. Goetz, A. Schmehl, C. W. Schneider, R. R. Schulz, H. Hilgenkamp, and J. Mannhart

Abstract—The critical-current density of grain boundaries in high- $T_c$  superconductors was enhanced to values exceeding the previously known limits both at 4.2 K and at 77 K. Noting the importance of space-charge layers and of the  $d_{\chi^2,y^2}$ -wave pairing symmetry on grain-boundary transport, we have established a model that provides a comprehensive description of the grain boundaries and proposes ways for their improvement, such as overdoping of the grains and of their boundaries. Exploring as example the effects of overdoping of YBa<sub>2</sub>Cu<sub>3</sub>O<sub>7-5</sub> with Ca, we enhanced significantly the critical current densities and decreased the normal-state resistivities of grain boundaries to unprecedented values.

By introducing doping heterostructures to overdope grain boundaries selectively over a few nanometers by benefiting from grain boundary diffusion, the enhancement of the criticalcurrent density is achieved at all temperatures up to  $T_c$ . At 77 K, critical current densities are obtained which before had been found only at 4.2 K. This concept is proposed as a practical and cost-effective route to enhance the performance of high- $T_c$ coated conductors fabricated by ion beam assisted deposition (IBAD) [1]-[4] or by the rolling assisted biaxially aligned substrate process (RABITS) [5].

*Index Terms*—critical currents, doping, grain boundary, Josephson junctions

#### I. INTRODUCTION

THE ENHANCEMENT of grain boundary critical current densities is a challenge which is key for many large scale applications of high- $T_c$  superconductivity. The reasons for this are well known: for coated conductors to be competitive with conventional technologies, their critical current densities have to be increased. In principle, there are two ways to enhance grain boundary critical currents for bulk applications: a) to accurately align the grains in all directions [6] and b) to increase the critical current densities of grain boundaries for a given spread of misorientations. We show,

Manuscript received September 17, 2000. This work was supported by the Bundesministerium f. Forschung und Technologie (BMBF project 6318) and by the Royal Dutch Academy of Sciences.

Rutherford Back Scattering experiments were performed at the FZ Karlsruhe, which is gratefully acknowledged.

J. Mannhart, H. Bielefeldt, B. Goetz, G. Hammerl, A. Schmehl, C. W. Schneider, R. R. Schulz, and H. Hilgenkamp are with the Center for Electronic Correlations and Magnetism, Institute of Physics, University of Augsburg, D-86135 Augsburg, Germany.

H. Hilgenkamp is also with the Low Temperature Division and the MESA+ Institute, University of Twente, P.O. Box 217, 7500 Enschede, The Netherlands.

that the transport properties of grain boundaries with a given misorientation can be optimized and the critical current density be significantly enhanced at all temperatures by doping of the superconductors. In addition it is pointed out that the process developed is a suitable means to tailor the properties of Josephson junctions, which may or may not be based on grain boundaries, as well as of other electronic devices relying on interfaces or surfaces involving high- $T_c$  superconductors.

## II. MECHANISMS OF CHARGE TRANSPORT ACROSS GRAIN BOUNDARIES

As far as applications are concerned, superconductors are usually regarded as canonical metals like for example Nb, Pb or Al, with large carrier densities and very small electric screening lengths as described in the Thomas-Fermi model. Contacts between such metals or grain boundaries within them have an ohmic resistance which is very small [7]. Semiconductors behave differently. Due to their much smaller carrier densities their screening lengths are larger, and consequently space-charge layers, band bending and Schottky contacts are ubiquitous phenomena [8]. Similarly, in most oxides, well known examples being given by doped SrTiO<sub>3</sub>, BaTiO<sub>3</sub>, and ZnO, grain boundaries are controlled by charging and band bending [9].

The presence of charges at grain boundaries in high- $T_c$  superconductors has been considered early on [10], and the existence of positive charges at the boundaries was demonstrated by detailed Z-contrast scanning transmission electron microscopy studies of grain boundaries in YBa<sub>2</sub>Cu<sub>3</sub>O<sub>7-8</sub> films [11].

Like many other oxides, the high- $T_c$  cuprates are characterized by relatively small carrier densities (a few  $10^{21}$ /cm<sup>3</sup>). Furthermore, the dielectric constants  $\varepsilon_r$  of the high- $T_c$  cuprates are non-negligible (see e.g. [12]-[14]). Therefore space-charge effects and band bending phenomena have to be considered to be present in the cuprates, which cause drastic differences between the physics of interfaces involving high- $T_c$  superconductors and the interface physics of conventional superconductors.

Based on such considerations we have proposed that, besides strong effects arising from the microstructure of the grain boundaries and from the  $d_x 2_{-y} 2$ -wave pairing symmetry of the high- $T_c$  superconductors, the transport across the high- $T_c$  grain boundaries is affected by band bending and by space-charge layers formed inside the grains close to the grain boundaries, over a distance given by the electrostatic screening length of the grains [15], [16]. In these space-charge layers, which typically are depletion layers, the density of mobile holes is strongly decreased. Consequently, the order parameter is thought to be reduced, too, and, for strong enough depletion, the cuprate is expected to undergo the phase transition into the insulating state and to form a tunneling barrier (see Fig. 1). Due to the faceted microstructure of the grain boundaries and the spatial distribution of the charges present at the boundary, this tunneling barrier will be inhomogeneous. A quantitative treatment of this model has been worked out by the Wisconsin group [18].



Fig. 1. Possible scenario for bending of the electronic band structure of high- $T_c$  cuprates at a grain boundary. In the example shown, at the grain boundary interface depletion layers are formed, which cause a depression of the order parameter and a transition of the cuprate into the insulating state in the region close to the interface (from [17]).

This understanding suggests doping to be a key to enhance the critical current density and to decrease the normal state resistance of grain boundaries in high- $T_c$  superconductors. First, overdoping of the grains is a means to reduce the electrostatic screening lengths and thereby the width of the space-charge layers. Second, by substituting excessively charged cations at the boundary by cations with a smaller valency, the built-in potential at the boundary is lowered, which reduces the height and the width of the tunneling barrier. In YBa<sub>2</sub>Cu<sub>3</sub>O<sub>7-8</sub>, for example, both effects have been predicted to be caused by partial replacement of Y<sup>3+</sup> with Ca<sup>2+</sup> [19]. This substitution is known to overdope the superconductor [20], and the replacement of Y<sup>3+</sup> by Ca<sup>2+</sup> at the boundary is expected to reduce the amount of positive charge present at the boundary layer. Partial replacement of Cu<sup>2+</sup> by Co<sup>3+</sup> is thought to cause the opposite effects and thus to decrease the grain boundary critical current densities [19].

It is noted that doping of grain boundaries has been explored by other groups before [21]-[26], but to our knowledge a systematic  $J_c$ -enhancement has never been reported.

## **III. MEASUREMENTS**

#### A. Homogeneously Doped Bicrystalline Films

To study the influence of doping  $YBa_2Cu_3O_{7-\delta}$  with Ca or with Co on grain boundary transport, bicrystalline films of  $Y_{1-x}Ca_xBa_2Cu_3O_{7-\delta}$  and of  $YBa_2Cu_{3-\nu}Co_{\nu}O_{7-\delta}$  were grown by pulsed laser deposition from polycrystalline  $Y_{1-x}Ca_xBa_2Cu_3O_{7-\delta}$  and  $YBa_2Cu_{3-\nu}Co_{\nu}O_{7-\delta}$  targets with  $0 \le x \le 1$ 0.4 and  $0 \le y \le 0.1$ . SrTiO<sub>3</sub> bicrystals with [001] tilt grain boundaries were used as substrates. After deposition, the samples were cooled down over an hour in an oxygen atmosphere of 0.4 bar. These are our standard conditions for the oxidation of YBa2Cu3O7-8 films [19], [27]. In several cases, after measuring  $J_c$ , post-anneal experiments were performed. These experiments confirmed that for Ca-doped samples this cooldown-process results in overdoped films [19]. Bridges straddling the grain boundaries in the typically 100-150 nm thick films were patterned by standard photolithography and wet etching to widths of 3-6 µm. Critical current densities  $J_c$  were obtained from the ratios of the critical currents and the cross-sectional areas A of the bridges, as measured for each of the bridges by atomic force microscopy.

In Fig. 2,  $J_c$  and the normal state resistivity  $R_nA$  at 4.2 K are presented for 24° boundaries as a function of the Ca or Co-concentrations x and y. As shown in Fig. 2a, with increasing Ca content,  $J_c$  increases to values as high as  $6.5*10^6$  A/cm<sup>2</sup> for x = 0.3. This is an order of magnitude larger than the critical current densities of the equivalent undoped samples. For a Ca concentration of x = 0.4  $J_c$  is reduced again, which is attributed to the fact that this concentration exceeds the solubility limit for Ca in YBa<sub>2</sub>Cu<sub>3</sub>O<sub>7.8</sub>. As expected, the critical current density is reduced by Co-doping.

As shown by Fig. 2b, the  $R_nA$ -values decrease continuously with increasing Ca-content to resistivities as small as  $2.5*10^{-10} \Omega \text{cm}^2$ . Due to this decrease also the  $I_cR_n$ -product drops with increasing  $J_c$ , as shown in Fig. 3. This



Fig. 2. Dependence of the critical current density  $J_c$  (a) and of the normal state resistance  $R_n A$  (b) of symmetric 24° [001]-tilt grain boundaries in  $Y_{1,x}Ca_xBa_2Cu_3O_{7.5}$  and in YBa<sub>2</sub>Cu<sub>3-y</sub>Co<sub>y</sub>O<sub>7.5</sub> films on the Ca and Co-concentrations x and y at T = 4.2 K (after Ref. 19).

behavior is not surprising since overdoping reduces the  $I_cR_n$  product together with the  $T_c$  and increases the  $J_c$  along with the coupling of the grain boundaries.

In Fig. 4, the critical current densities and normal state resistivities of Y<sub>0.7</sub>Ca<sub>0.3</sub>Ba<sub>2</sub>Cu<sub>3</sub>O<sub>7.8</sub> bicrystalline films are plotted as a function of grain boundary angle. As shown, significant increases of  $J_c$  are also achieved for  $30^\circ$ boundaries. We note that even in applied magnetic fields of up to 3 T large increases of  $J_c$  are now reported for 5° junctions by the group of the University of Wisconsin [30]. For 45° boundaries the enhancements are smaller, which is attributed to the fact that the  $d_x 2_{-v} 2$ -wave pairing symmetry has a very strong influence on these junctions. It is remarkable that for all doping concentrations and temperatures the asymmetric 45° grain boundaries showed anomalous dependencies of their critical currents on applied magnetic fields [31], which provides evidence that in the whole parameter range explored the symmetry of  $Y_{1-x}Ca_xBa_2Cu_3O_{7-\delta}$  is dominated by the  $d_x2_{-\nu}2$ -wave component.

With increasing Ca concentration, the  $T_c$  of the samples drops rapidly, as shown in Fig. 5. Due to this  $T_c$  reduction, for a measurement temperature of 77 K, Ca doping of the YBa<sub>2</sub>Cu<sub>3</sub>O<sub>7- $\delta$ </sub> grains leads to minor increases of  $J_c$  at best (see Fig. 6).

## B. Doping Multilayers and Superlattices

To achieve large critical current densities across grain boundaries at 77 K it is obviously desirable to obtain good grain boundary coupling and at the same time to preserve a large  $T_c$  of the grains. To achieve this goal, we tried to overdope the superconductors locally at the grain boundaries while keeping the grains optimally doped [27]. To overdope the grain boundaries we devised dopingheterostructures such as  $Y_{1-x}Ca_xBa_2Cu_3O_{7-\delta}$  bilayers or superlattices, anticipating that during film growth calcium diffuses along the grain boundary into the YBa<sub>2</sub>Cu<sub>3</sub>O<sub>7- $\delta$ </sub> layers. As the diffusion coefficient along the grain boundary is presumed to exceed considerably the diffusion coefficient in the grains, this process is expected to enhance the calciumconcentration locally at the grain boundaries (see Fig. 7). Therefore the YBa<sub>2</sub>Cu<sub>3</sub>O<sub>7- $\delta$ </sub> layers are foreseen to have high intergrain  $J_c$ -values at 77 K, combined with good superconducting properties of the grains [27].



Fig. 3. Dependence of the characteristic voltage  $I_cR_n$  of symmetric 24° [001]-tilt grain boundaries in Y<sub>1-x</sub>Ca<sub>x</sub>Ba<sub>2</sub>Cu<sub>3</sub>O<sub>7-δ</sub> and in YBa<sub>2</sub>Cu<sub>3-y</sub>Co<sub>y</sub>O<sub>7-δ</sub> films on the Ca and Co-concentrations x and y at T = 4.2 K (from Ref. 28).



Fig. 4. Dependence of the critical current density  $J_c$  (a) and of the normal state resistance  $R_nA$  (b) of [001]-tilt grain boundaries in  $Y_{1,x}Ca_xBa_2Cu_3O_{7.5}$  films on the grain boundary angle for various doping concentrations at T = 4.2 K.

In the course of these studies, several hundred grain boundary junctions formed by a variety of doping heterostructures, such as bilayers, trilayers, and superlattices were fabricated (see Figs. 8-10), predominantly grown on SrTiO<sub>3</sub> bicrystals containing 24° [001] tilt boundaries. This angle was chosen, as in the past 24° grain boundaries have been widely characterized by many groups. In the following their characteristic behavior will be summarized.

Fig. 11 shows a current-voltage characteristic typical for all doping multilayers investigated. It displays a clear RSJtype Josephson behavior. This agrees with the magnetic field dependencies of the critical current, which, as shown in Fig. 12, are typical for standard 24° grain boundary Josephson junctions. Do the doping heterostructures indeed yield large grain boundary critical current densities at 77 K? The answer to this question is provided by Fig. 13, which presents the  $J_c(T)$ dependencies of four samples containing 24° [001] tilt grain boundaries: an undoped YBa<sub>2</sub>Cu<sub>3</sub>O<sub>7.8</sub> film, a homogeneously doped one, and two doping multilayers. The grain boundary of the undoped film plotted has a critical current density of  $5.2*10^5$  A/cm<sup>2</sup> and  $5.5*10^4$  A/cm<sup>2</sup> at 4.2 K and at 77 K, respectively, which agrees with the literature values for very good samples. The critical current density of the homogeneously doped Y<sub>1-x</sub>Ca<sub>x</sub>Ba<sub>2</sub>Cu<sub>3</sub>O<sub>7.8</sub> film is huge at 4.2 K, but, as discussed, is vanishing at 77 K. This problem is solved by the doping multilayers. In the plot, the behavior of a typical bilayer is shown, together with the dependence of



Fig. 5. Dependence of the critical temperature  $T_c$  of symmetric 24° [001]-tilt grain boundaries in Y<sub>1-x</sub>Ca<sub>x</sub>Ba<sub>2</sub>Cu<sub>3</sub>O<sub>7.8</sub> films on the doping concentration x (after Ref. 28).



Fig. 6. Dependence of the critical current density  $J_c$  of symmetric 24° [001]tilt grain boundaries in  $Y_{1,x}Ca_xBa_2Cu_3O_{7.\delta}$  films on the doping concentration x at T = 77 K (from Ref. 32).

2834





the best sample prepared, which was a  $Y_{1-x}Ca_xBa_2Cu_3O_{7-\delta}$  /  $YBa_2Cu_3O_{7-\delta}$  /  $Y_{1-x}Ca_xBa_2Cu_3O_{7-\delta}$  trilayer. As expected, the multilayers have a high  $T_c$ , for all samples  $T_{c0}$  exceeded 90 K. Consequently the grain boundaries support large critical current densities at high temperatures, which well exceed those of the YBa\_2Cu\_3O\_{7-\delta} films in the entire temperature range of  $T < T_c$ . Specifically, the trilayer shown achieved at 77 K a critical current density of  $3.3*10^5$  A/cm<sup>2</sup>, which equals the critical current density usually obtained at liquid nitrogen temperatures for 7° boundaries, or the typical critical current densities at 4.2 K (see Fig. 4).

## IV. OUTLOOK

These results reveal that doping is an effective tool to optimize grain boundary Josephson junctions. The processes employed are cheap and, as much as we know today, readily compatible with the coated conductor technologies. Therefore we propose to apply this advancement to RABITS and IBAD to further improve the performance/cost ratio of the coated conductors.

Also, doping is a powerful technique to modify grain boundary Josephson junctions used in electronic applications. In this work we have focussed on the changes of  $J_c$ ,  $R_nA$  and the  $I_cR_n$ -product, but doping is seen to also affect other junction properties, such as junction capacitance [33], noise, reproducibility or stability. Since band bending is also a concern for other types of high- $T_c$  Josephson junctions, such as ramp-type junctions, or of other interfaces and surfaces involving high- $T_c$  cuprates, we are strongly convinced that doping is a tool to optimize their properties, too (see also [34]).

Comparable to the case of semiconducting electronics, doping introduces several degrees of freedom to modify interfaces in superconductors. For example, instead of calcium other doping elements, or even combinations of various dopants, may be utilized. Furthermore, Y may be



Fig. 8. Sketch of the doping bilayers used in the experiments (after Ref. 27).



Fig. 9. Sketch of the doping trilayers investigated (after Ref. 27).



Fig. 10. Sketch of the doping superlattices studied (after Ref. 27).

replaced by a rare earth element which due to slightly different electronic properties, or due to a higher  $T_c$  of the cuprate superconductor, leads to improved grain boundary behavior. For electronic applications, new possibilities for circuit design are provided by the fact that the doping elements or their concentration can be varied across the surface of a chip or between layers in multilayer structures [28].



Fig. 11. Typical I(V)-characteristics of 24° grain boundaries doping multilayers measured at 77 K. The measurements were done with a YBa<sub>2</sub>Cu<sub>3</sub>O<sub>7.8</sub>/Y<sub>0.7</sub>Ca<sub>0.3</sub>Ba<sub>2</sub>Cu<sub>3</sub>O<sub>7.8</sub> bilayer with layer thicknesses of 160 nm and 20 nm, respectively. The width of the superconducting bridge was 7.7  $\mu$ m.

## V. SUMMARY

Guided by the concept of band bending, we have studied the effects of doping of high- $T_c$  superconductors on the transport properties of grain boundaries and have found it to be a powerful tool for their optimization. For example, by using  $YBa_2Cu_3O_{7-\delta}$  based doping multilayers, grain boundary critical current densities have been achieved which at 77 K equal the values usually measured at 4.2 K.



Fig. 12. Magnetic field dependence of the critical currents of 24° grain boundaries in two doping multilayers. a) a multilayer consisting of 6 layers of YBa<sub>2</sub>Cu<sub>3</sub>O<sub>7. $\delta$ </sub> and 5 layers of Y<sub>0.9</sub>Ca<sub>0.1</sub>Ba<sub>2</sub>Cu<sub>3</sub>O<sub>7. $\delta$ </sub>, of about equal layer thicknesses, the total film thickness being ~ 290 nm, the width of the bridge crossing the grain boundary ~ 4.7 µm; b) a YBa<sub>2</sub>Cu<sub>3</sub>O<sub>7. $\delta$ </sub> / Y<sub>0.7</sub>Ca<sub>0.3</sub>Ba<sub>2</sub>Cu<sub>3</sub>O<sub>7. $\delta$ </sub>, bilayer. The total film thickness of this sample equals ~ 170 nm, the thickness of the Cadoped top-layer ~ 20 nm; and the grain boundary width ~ 6.3 µm.

2836





#### REFERENCES

- Y. Iijima, N. Tanabe, O. Kohno, and Y. Ikeno, "In-plane aligned YBa<sub>2</sub>Cu<sub>3</sub>O<sub>7-x</sub> thin films deposited on polycrystalline metallic substrates," *Appl. Phys. Lett.*, vol. 60, pp. 769-771, 1992.
- [2] R.P. Reade, P. Berdahl, R.E. Russo, and S.M. Garrison "Laser deposition of biaxially textured yttria-stabilized zirconia buffer layers on polycrystalline metallic alloys for high critical current Y-Ba-Cu-O thin films," *Appl. Phys. Lett.*, vol. 61, pp. 2231-2233, 1992.
- [3] X.D. Wu, S.R. Foltyn, P.N. Arendt, W.R. Blumenthal, I. H. Campbell, J.D. Cotton, J.Y. Coulter, W.L. Hults, M.P. Maley, H.F. Safar and J.L. Smith, "Properties of YBa<sub>2</sub>Cu<sub>3</sub>O<sub>7.8</sub> thick films on flexible buffered metallic substrates," *Appl. Phys. Lett.*, vol. 67, pp. 2397-2399, 1995.
- [4] J. Dzick, J. Wiesmann, J. Hoffmann, K. Heinemann, F. Garcia-Moreno, A. Isaev, and H.C. Freyhardt, "YSZ buffer layers on large technical substrates," *IEEE Trans. Appl. Supercond.*, vol. 9, pp. 2248-2251, 1999.
- [5] D.P. Norton, A. Goyal, J.D. Budai, D.K. Christen, D.M. Kroeger, E.D. Specht, Q. He, B. Saffian, M. Paranthaman, C.E. Klabunde, D.F. Lee, B.C. Sales, and F.A. List, "Epitaxial YBa<sub>2</sub>Cu<sub>3</sub>O<sub>7</sub> on biaxially textured nickel [001]: an approach to superconducting tapes with high critical current density," *Science*, vol. 274, pp. 755-757, 1996.
- [6] D. Dimos, P. Chaudhari, and J. Mannhart, "Superconducting transport properties of grain boundaries in YBa<sub>2</sub>Cu<sub>3</sub>O<sub>7</sub> bicrystals," *Phys. Rev. B*, vol. 41, pp. 4038-4049, 1990.
- [7] I. Nakamichi, "The electrical resistivity due to grain boundary and the boundary structure," J. Sci. Hiroshima Univ., Ser. A, vol. 54, pp. 49-84, 1990.
- [8] W.E. Taylor, N.H. Odell, and H.Y. Fan, "Grain boundary barriers in germanium," *Phys. Rev.*, vol. 88, pp. 867-875, 1952.

- [9] See, e.g., Electroceramics VI, Reports of the Electroceramics VI'98, Montreux, Switzerland, 24-27 August 1998, in "Journal of the European Ceramic Society," Elsevier Science Ltd., vol. 19, 1999, N. Setter, E. Colla, and D. Damjanovic (editors).
- [10] P. Chaudhari, D. Dimos, and J. Mannhart, "Critical currents in singlecrystal and bicrystal films," in *Earlier and Recent Aspects of Superconductivity*, ed.: J.G. Bednorz and K.A. Müller, Springer, 1990, pp. 201-207.
- [11] N.D. Browning, J.P. Buban, P.D. Nellist, D.P. Norton, M.F. Chrisholm, and S.J. Pennycook. "The atomic origin of reduced critical currents at [001] tilt grain boundaries in YBa<sub>2</sub>Cu<sub>3</sub>O<sub>7.6</sub> thin films," *Physica C*, vol. 294, pp. 183-193, 1998.
- [12] Z. Trybula, J. Stankowski, and J. Baszynski, "Dielectric study of YBa<sub>2</sub>Cu<sub>3</sub>O<sub>7.5</sub> ceramic in a microwave field," *Physica C*, vol. 156, pp. 485-488, 1988.
- [13] S.V. Varyukhin and O. Parfenov, "Changes in the static dielectric constant of YBa<sub>2</sub>Cu<sub>3</sub>O<sub>y</sub> and PrBa<sub>2</sub>Cu<sub>3</sub>O<sub>y</sub> toward the insulator-metal transition," *JETP Lett.*, vol. 58, pp. 101-105, 1993.
- [14] D. Reagor, E. Ahrens, S.-W. Cheong, A. Migliori, and Z. Fisk, "Large dielectric constants and massive carriers in La<sub>2</sub>CuO<sub>4</sub>," *Phys. Rev. Lett.*, vol. 62, pp. 2048-2051, 1989.
- [15] J. Mannhart and H. Hilgenkamp, "Wave function symmetry and its influence on superconducting devices," Inst. Phys. Conf. Ser., no. 158, pp. 1-6, 1997.
- [16] J. Mannhart and H. Hilgenkamp, "Possible influence of band bending on the normal state properties of grain boundaries in high- $T_c$ superconductors," *Materials Science and Engineering B*, vol. 56, pp. 77-85, 1998.
- [17] J. Mannhart, H. Bielefeldt, B. Goetz, H. Hilgenkamp, A. Schmehl, C.W. Schneider, and R.R. Schulz, "Grain boundaries in high-T<sub>c</sub> superconductors: insights and improvements," *Phil. Mag.*, vol. B 80, pp. 827-834, 2000.

- [18] A. Gurevich and E.A Pashitskii, "Current transport through low-angle grain boundaries in high-temperature superconductors," *Phys. Rev. B*, vol. 57, pp.13878-13893, 1998.
- [19] A. Schmehl, B. Goetz, R.R. Schulz, C.W. Schneider, H. Bielefeldt, H. Hilgenkamp, and J. Mannhart, "Doping-induced enhancement of the critical currents of grain boundaries in YBa<sub>2</sub>Cu<sub>3</sub>O<sub>7.8</sub>," *Europhys. Lett.*, vol. 47, pp. 110-115, Apr. 1999.
- [20] J.T. Kucera and J.C. Bravman, "Transport characterization of calciumdoped YBa<sub>2</sub>Cu<sub>3</sub>O<sub>7.5</sub> thin films," *Phys. Rev. B*, vol. 51, pp. 8582-8590, 1995.
- [21] P. Chaudhari, D. Dimos, J. Mannhart, and C.C. Tsuei, unpublished (1988).
- [22] M. Kawasaki, P. Chaudhari, and A. Gupta, "1/f noise in YBa<sub>2</sub>Cu<sub>3</sub>O<sub>7.8</sub> superconducting bicrystal grain-boundary junctions," *Phys. Rev. Lett.*, vol. 68, pp. 1065-1068, 1992.
- [23] Z.G. Ivanov, E.A. Stepantsov, A.Yu. Tzalenchuk, and T. Claeson, "Properties of locally doped bi-crystal grain boundary junctions," *Physica B*, vol. 194-196, pp. 2187-2188, 1994.
- [24] Z.W. Dong, V.C. Matijasevic, P. Hadley, S.M. Shao, and J.E. Mooij, "Electric field effect in bicrystal junctions," *IEEE Trans. Appl. Supercond.*, vol. 5, pp. 2879-2882, 1995.
- [25] B. Mayer, J. Mannhart, and H. Hilgenkamp, "Electric field controllable Josephson junctions of high quality in high-T<sub>c</sub> superconductors," *Appl. Phys. Lett.*, vol. 68, pp. 3031-3033, 1996.
- [26] G.Y. Sung, J.D. Suh, and S.-G. Lee, "Properties of doped-YBCO bicrystal grain boundary junctions for Josephson field effect transistor," *Physica C*, vol. 282-287, pp. 2475-2476, 1997.
- [27] G. Hammerl, A. Schmehl, R.R. Schulz, B. Goetz, H. Bielefeldt, C.W. Schneider, H. Hilgenkamp, and J. Mannhart, "Enhanced supercurrent density in polycrystalline YBa<sub>2</sub>Cu<sub>3</sub>O<sub>7.8</sub> at 77 K from calcium doping of grain boundaries," *Nature*, vol. 407, pp. 162-164, 2000.
- [28] C.W. Schneider, R.R. Schulz, B. Goetz, A. Schmehl, H. Bielefeldt, H. Hilgenkamp, and J. Mannhart, "Tailoring of high-T<sub>c</sub> Josephson junctions by doping their electrodes," *Appl. Phys. Lett.*, vol. 75, pp. 850-852, 1999.
- [29] H. Hilgenkamp and J. Mannhart, "Superconducting and normal-state properties of YBa<sub>2</sub>Cu<sub>3</sub>O<sub>7.8</sub>-bicrystal grain boundary junctions in thin films," *Appl. Phys. Lett.*, vol. 73, pp. 265-267, 1998.
- [30] G.A. Daniels, A. Gurevich, and D. Larbalestier, "Improved strong magnetic field performance of low angle grain boundaries of calcium and oxygen overdoped YBa<sub>2</sub>Cu<sub>3</sub>O<sub>x</sub>," *Appl. Phys. Lett.*, vol. 77, pp. 3251-3253, 2000.
- [31] H. Hilgenkamp, J. Mannhart, and B. Mayer, "Implications of d<sub>x2-y2</sub> symmetry and faceting for the transport properties of grain boundaries in high-T<sub>c</sub> superconductors," *Phys. Rev. B*, vol. 53, pp. 14586-14593, 1996.
- [32] J. Mannhart, H. Bielefeldt, B. Goetz, H. Hilgenkamp, A. Schmehl, C.W. Schneider, and R.R. Schulz, "Doping Induced Enhancement of the Critical Currents of Grain Boundaries in High-T<sub>c</sub> Superconductors," *Proceedings of the M<sup>2</sup>S 2000, Houston (USA)*, to be published in *Physica C*.
- [33] J.H.T. Ransley et al., to be published.
- [34] A.H. Sonnenberg, I. Oomen, H. Hilgenkamp, G.J. Gerritsma, and H. Rogalla, "Sigma-Delta Converter in HTS Ramp Edge Technology," submitted to *IEEE Trans. Appl. Supercond.*, *Proceedings of the ASC* 2000, Virginia Beach.